

C1812C562JDGACTU

Aliases (C1812C562JDGAC7800) SMD Comm COG HV, Ceramic, 5,600 pF, 5%, 1,000 VDC, COG, SMD, MLCC, Ultra-Stable, Low Loss, Class I, 1812, 2.3 mm



Click here for the 3D model.

General Information		
Series	SMD Comm COG HV	
Style	SMD Chip	
Description	SMD, MLCC, Ultra-Stable, Low Loss, Class I	
Features	Ultra-Stable, Low Loss, Class I	
RoHS	Yes	
Termination	Tin	
Marking	No	
AEC-Q200	No	
Typical Component Weight	87 mg	
Shelf Life	78 Weeks	
MSL	1	

0% Loss/Decade Hour

100 GOhms

	Specifications	
	Capacitance	5,600 pF
+/-0.3mm	Measurement Condition	1 kHz 1.0Vrms
+/-0.3mm	Tolerance	5%
+/-0.20mm	Voltage DC	1000 VDC
MIN	Dielectric Withstanding Voltage	1,200 VDC
+/-0.35mm	Temperature Range	-55/+125°C
	Temp. Coefficient	COG
Omm, Plastic Tape	Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	30 ppm/C, 1kHz 1.0Vrms
	Dissipation Factor	0.1% 1 kHz 1.0Vrms

Aging Rate

Insulation Resistance

Packaging Specifications Comm. Plastic Tape R

2.3mm MIN 0.6mm +/-0.35mm

1812

4.5mm +

3.2mm +

2.5mm +

 Packaging
 T&R, 180mm

 Packaging Quantity
 500

Dimensions

Chip Size

L W

Т

S

В